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### **Applied Thermal Engineering**

journal homepage: www.elsevier.com/locate/apthermeng



# Hydraulic-thermal performance of vascularized cooling plates with semi-circular cross-section

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#### ARTICLE INFO

Article history: Received 26 April 2011 Accepted 22 September 2011 Available online 1 October 2011

Keywords: Constructal Vascular Dendritic Cooling plates Self-healing Self-cooling

#### ABSTRACT

Analytical and numerical studies are conducted to investigate the hydraulic and thermal performance of new vascular channels with semi-circular cross-sections. An analytical model is built to minimize the flow resistance in vascularized cooling plates and then vascular designs are created by using the proposed model. The analytical results show that the dimensionless global flow resistance for the configurations with semi-circular cross-sections, both the optimized and non-optimized constructs, is significantly higher than it is for the configurations with circular cross-sections. A numerical model for three-dimensional fluid flow and heat transfer characteristics of vascularized cooling plates is also presented. Then, to validate the analytical model, the flow resistances predicted by the analytical model are compared with numerical data subject to a fixed volume and a fixed pumping power, and favorable agreements between the numerical and analytical results are obtained as system size increases. It is also shown that the thermal resistances for the first and second optimized constructs are closely competitive across all working conditions, whereas the best architecture in the non-optimized configurations is the third construct among the cooling plates.

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#### 1. Introduction

Over the last few decades, thermal management has become a crucial issues in the design of electronic or automotive components because temperature affects their performance and reliability. Especially with the decrease in size of thermal systems, it is vital to dissipate their heat. Even the traditional convective cooling of these systems may lose its performance in some cases [1] and thus should be managed.

Effective flow architectures of several types are proposed because the design of the flow architecture has a significant effect on the operating performance of engineering equipment [2]. A new research direction for global optimization is based on the constructal law [3–6]. Among the engineered flow architectures derived from the constructal law are the tree-shaped (dendritic) designs. Tree-shaped flow configurations offer maximum access between one point (inlet, or outlet) and an infinite number of points (area, volume) [7]. Numerous studies [8–19] have been conducted to examine the development of flow architecture using the constructal law. Wechsatol *et al.* [20] developed general rules to

construct asymmetric trees. They also showed that asymmetric bifurcation provides lower flow resistance than symmetric bifurcation. We have characterized the thermo-hydraulic performance of vascular designs with circular cross-sections [2]. More recently, Kim *et al.* [21] showed that the main features of a steam generator can be determined based on the method of constructal design. They also showed that the total heat transfer rate increases proportionately to the length of the entire heat exchanger.

Polymer electrolyte membrane fuel cells (PEMFCs) are the typical examples where cooling is important: local hot spots due to an improperly designed cooling system can accelerate the mechanical damage of polymer electrolyte membranes, impairing the reliability of PEMFCs [22]. In reality, a temperature gradient of a magnitude of  $\sim 5~^{\circ}\text{C}$  has been found across the cathode. This temperature gradient has a significant influence on the water and heat transport in a PEMFC [23]. Thus, dealing with hot spots is one of the biggest challenges for cooling plates in a PEMFC.

Chen *et al.* [24] studied the cooling performance of several serpentine and parallel channel designs through a numerical simulation of fluid flow and heat transfer within the cooling plates. They concluded that the cooling effect of serpentine-type cooling modes could be better than that of parallel-type cooling modes in terms of temperature uniformity and maximum temperature. Similarly, Choi

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Nomenclature		V <sub>c</sub> x, y, z	total channel flow volume, m <sup>3</sup> , Table 1 z Cartesian coordinates	
Α	area, m <sup>2</sup>	X, Y, W	inner dimensions of vascularized unit, mm, Figs. 1	
C	Constant factor, $m^2$ s <sup>-1</sup> , Eqs. (3) and (4)		and 2	
d	elemental length scale, m			
$D_h$	hydraulic diameter, m, Eq. (6) and Table 1	Greek s	ymbols	
$D_i$	channel diameter of the ith channel, m	$\Delta P$	pressure difference, Pa	
$D_{1h}$	hydraulic diameter of thin channels, m	ρ	fluid density, kg m <sup>-3</sup>	
$D_{2h}$	hydraulic diameter of thick channels, m	$\phi$	porosity, Eq. (1)	
$L_i$	length of the ith channel, m	$\mu$	fluid dynamic viscosity, kg s <sup>-1</sup> m	
ṁ	mass flow rate, kg s $^{-1}$	ν	fluid kinematic viscosity, m <sup>2</sup> s <sup>-1</sup>	
$\dot{m}_{ m i}$	mass flow rate of the <i>i</i> th channel, kg $s^{-1}$	$\psi$	non-dimensional global flow resistance, Eq. (15)	
P	local pressure, Pa			
P	pumping power, W, Eq. (28)	Subscripts		
p	perimeter, m, Eq. (5)	comp	compensation of pressure drop along the inlet and	
$P_{\rm in}$	inlet pressure, Pa		outlet channels	
$P_{\text{out}}$	outlet pressure, Pa	i	channel rank	
q	total heat imposed on the cooling plate, W, Eq. (27)	in	inlet	
R	thermal resistance, K $W^{-1}$ , Eq. (27)	max	maximum	
Re	Reynolds number, Eq. (26)	out	outlet	
Sv	svelteness number, Eq. (2)			
$T_m$	mass-weighted average temperature, K, Eq. (25)	Supersc	Superscript	
$V_{\rm in}$	local mean velocity at inlet, m s <sup>-1</sup> , Eq. (26)	$\rightarrow$	Vector quantity	
V	element volume, m <sup>3</sup> , Eq. (1)			

et al. [25], using computational fluid dynamics (CFD) simulations, examined the performance of cooling plates for the PEMFC by comparing the numerical results for serpentine channels with those for parallel channels. They also showed that modified serpentinetype and modified parallel-type models are more cooling than those that are unmodified. Yu et al. [26] studied several multi-pass serpentine flow-field designs in order to achieve better heat management by using cooling plates. They demonstrated that multipass serpentine flow-field designs had better cooling performance than did conventional serpentine flow-field, in terms of both the maximum temperature and temperature uniformity. Recently, Kurnia et al. [27] studied the thermal performance of parallel, serpentine, wavy, coiled and novel hybrid channels. Likewise, despite several studies of the hydraulic and thermal performance of cooling plates, none of these models report the optimized cooling channel architectures (or multi-scale based) based on the constructal law.

As noted above, while there have been some theoretical studies on the constructal law or on a multi-scale approach, the studies meant to validate previous research results or to optimize the geometric configurations of the cooling plates with semi-circular cross-sections for more practical applications have been limited. This research therefore uses analytical and numerical investigations to evaluate the hydraulic and thermal performance of cooling plates with semi-circular cross-sections which provide a solution to the fabrication of test sections. In general, the circular section does

not represent the channel cross-sections being produced in engineering devices very well, while the stacked plates for etched passages is represented by a semi-circle. The impact of these characteristics on the relative heat transfer and pressure drop performance of such channels has not been quantified [28]. In this study, three types of design are considered on a square flat volume consisting of  $10 \times 10$ ,  $20 \times 20$ , and  $50 \times 50$  volume elements: a first-level construct (Fig. 1a), a second-level construct, and a third-level construct, respectively.

#### 2. Analytical model and method

#### 2.1. Geometry

The considered geometry in the study is a vascularized cooling body consisting of a square slab measuring  $X \times Y$  and having thickness W, where W is the dimension of the solid body in the direction perpendicular to the plane  $X \times Y$ , as shown in Fig. 1. The size of the square domain is measured in terms of  $N \times N$ , where N is the number of small square elements counted along one side (see Fig. 1b). New vascular designs for the volumetric bathing of the smart structures with volumetric functionalities (self-healing, cooling) are optimized by using the methodology which was explored in the previous research work [7]: one channel size versus two channel sizes, increasing complexity (1st, 2nd, and 3rd

 Table 1

 Geometric dimensions for the constructal configurations.

System size	Complexity	$V_{\rm c}~({\rm m}^3)$	d (m)	$D_h\left(D_{1h}=D_{2h}\right)(\mathbf{m})$	$D_{2h}\left(\mathbf{m}\right)$	$D_{1h}$ (m)	Sv
10 × 10	1st	$4 \times 10^{-6}$	$10^{-2}$	$1.868 \times 10^{-3}$	$2.856 \times 10^{-3}$	$1.582 \times 10^{-3}$	6.3
	2nd	$4  imes 10^{-6}$	$10^{-2}$	$1.803 \times 10^{-3}$	$2.418 \times 10^{-3}$	$1.276 \times 10^{-3}$	6.3
	3rd	$4\times 10^{-6}$	$10^{-2}$	$1.885 \times 10^{-3}$	$2.251 \times 10^{-3}$	$1.301 \times 10^{-3}$	6.3
$20 \times 20$	1st	$2  imes 10^{-6}$	$5  imes 10^{-3}$	$9.530 \times 10^{-4}$	$1.833 \times 10^{-3}$	$8.100 \times 10^{-4}$	7.9
	2nd	$2 \times 10^{-6}$	$5 \times 10^{-3}$	$9.330 \times 10^{-4}$	$1.566 \times 10^{-3}$	$6.560 \times 10^{-4}$	7.9
	3rd	$2\times 10^{-6}$	$5  imes 10^{-3}$	$9.550 \times 10^{-4}$	$1.417 \times 10^{-3}$	$6.490 \times 10^{-4}$	7.9
50 × 50	1st	$8 \times 10^{-7}$	$2  imes 10^{-3}$	$3.860 \times 10^{-4}$	$1.029 \times 10^{-3}$	$3.350 \times 10^{-4}$	10.8
	2nd	$8 \times 10^{-7}$	$2 \times 10^{-3}$	$3.830 \times 10^{-4}$	$9.000 \times 10^{-4}$	$2.780 \times 10^{-4}$	10.8
	3rd	$8 \times 10^{-7}$	$2\times 10^{-3}$	$3.860 \times 10^{-4}$	$8.010 \times 10^{-4}$	$2.720 \times 10^{-4}$	10.8

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